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(12) **United States Design Patent**
Tsubone et al.

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(54) **EARPHONE**
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(52) **U.S. Cl.**
USPC **D14/205**

(58) **Field of Classification Search**
USPC D14/205, 223, 372; 181/129, 130, 135; 379/430, 431; 381/380, 381, 374, 371, 381/370; 455/90.3, 569.1, 575.1; 345/7, 345/8
CPC H04R 1/1066; H04R 1/1016; H04R 5/033; H04R 5/0335; H04R 1/10; H04R 1/1091; H04R 1/02; H04R 1/105
See application file for complete search history.

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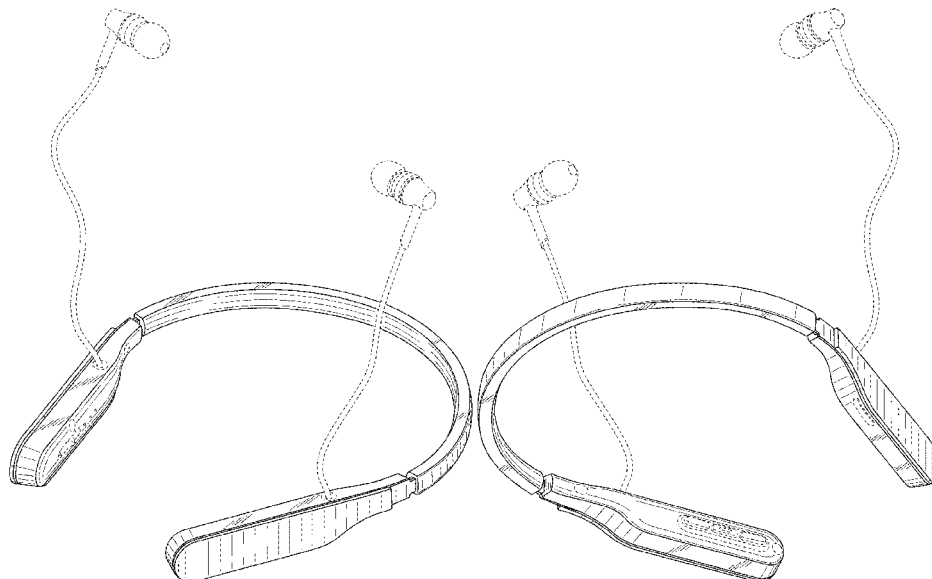
(57) **CLAIM**

The ornamental design for an earphone, as shown and described.

DESCRIPTION

FIG. 1 is a front perspective view of an earphone; FIG. 2 is a rear perspective view of the earphone; FIG. 3 is a front elevational view of the earphone; FIG. 4 is a rear elevational view of the earphone; FIG. 5 is a top plan view of the earphone; FIG. 6 is a bottom plan view of the earphone; FIG. 7 is a left side elevational view of the earphone; and, FIG. 8 is a right side elevational view of the earphone. In the drawing the claimed design is defined by the shaded surfaces; the broken lines depict unclaimed environment that forms no part of the claimed design.

1 Claim, 8 Drawing Sheets



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FIG. 1

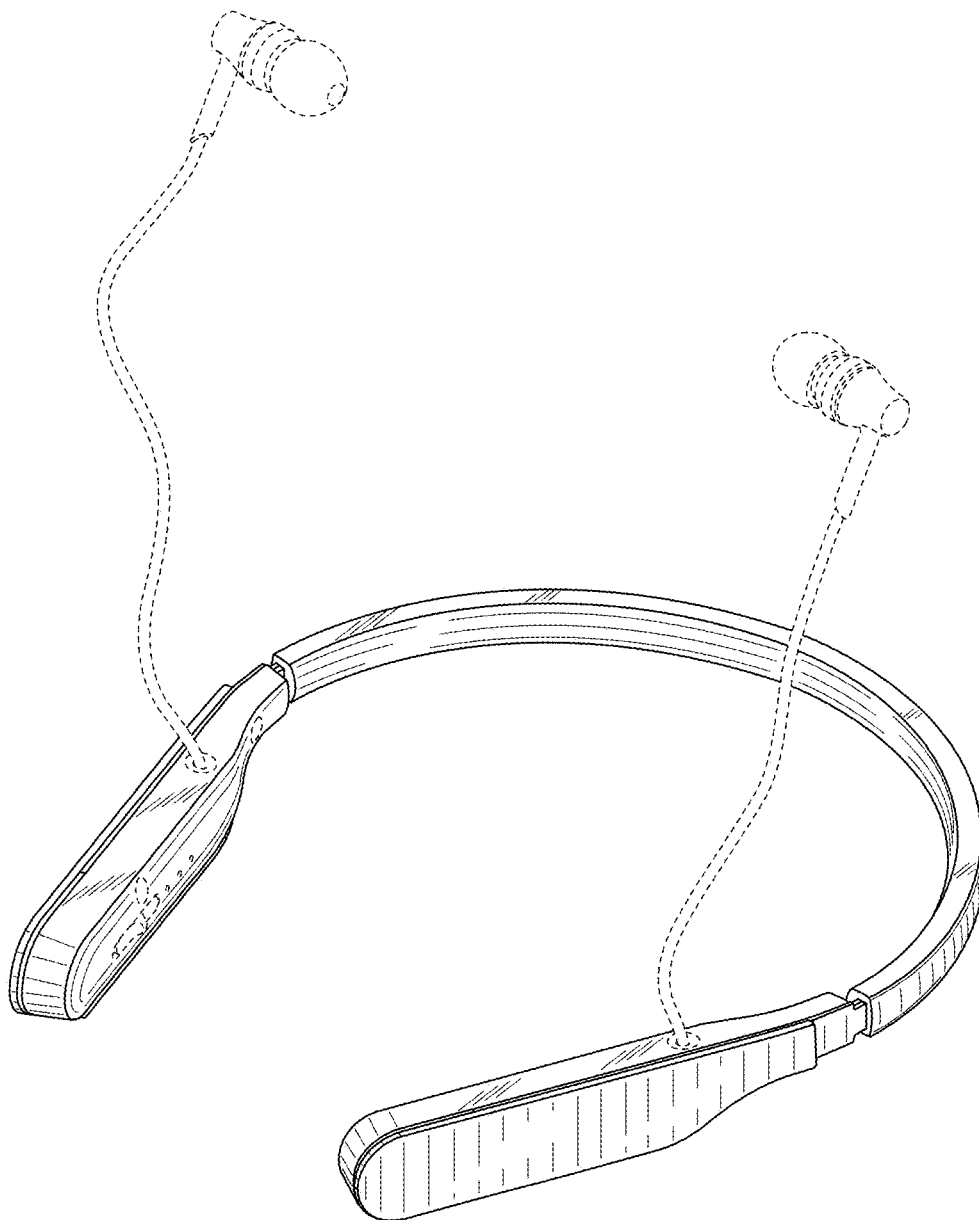


FIG. 2

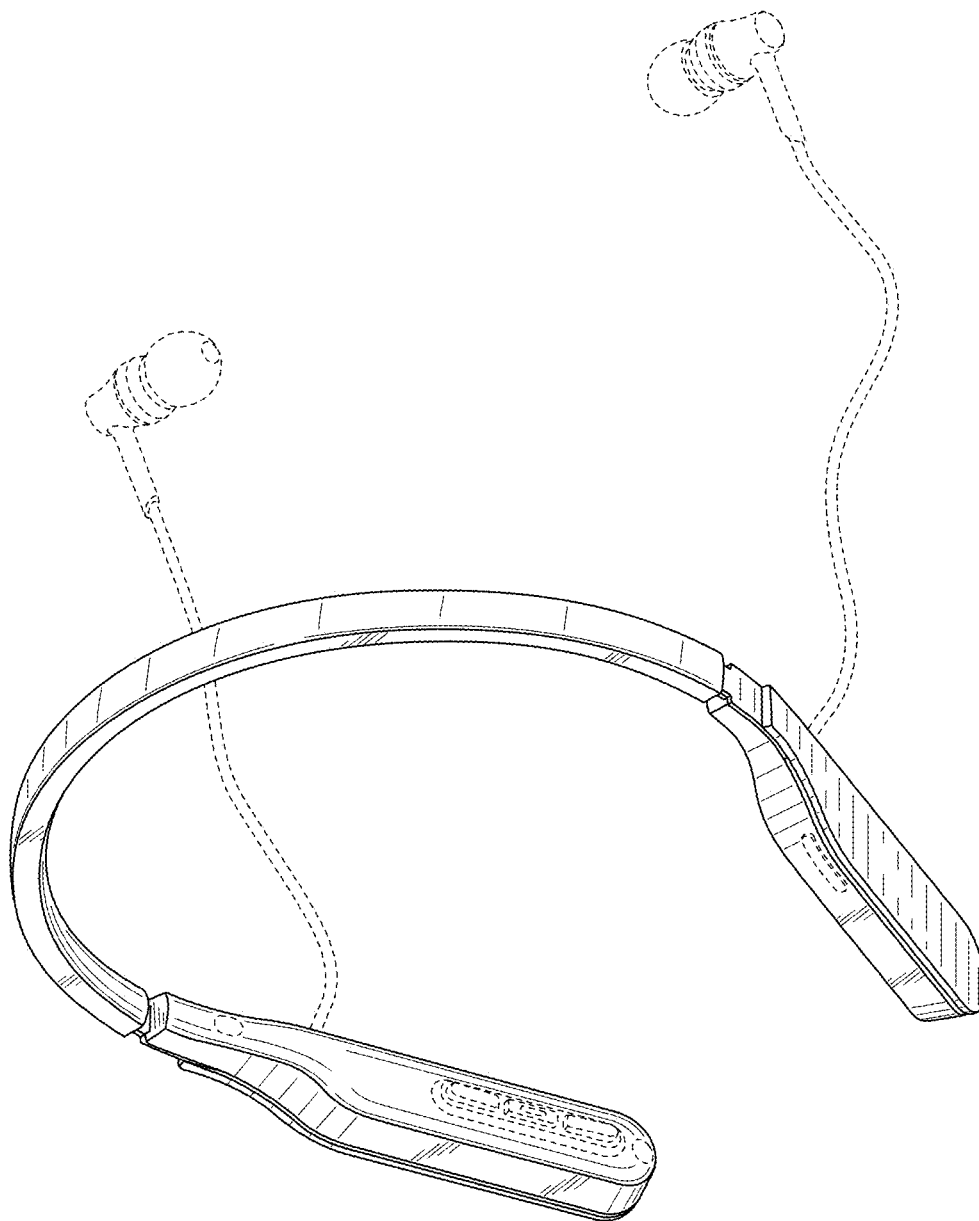


FIG. 3

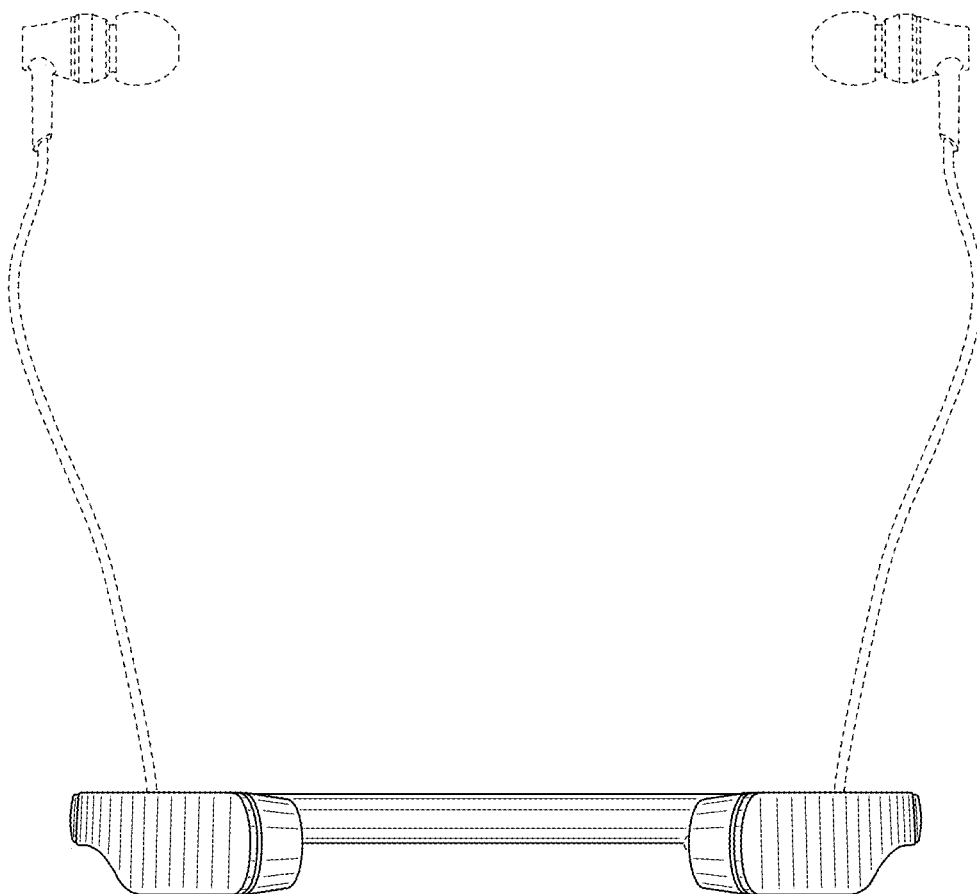


FIG. 4

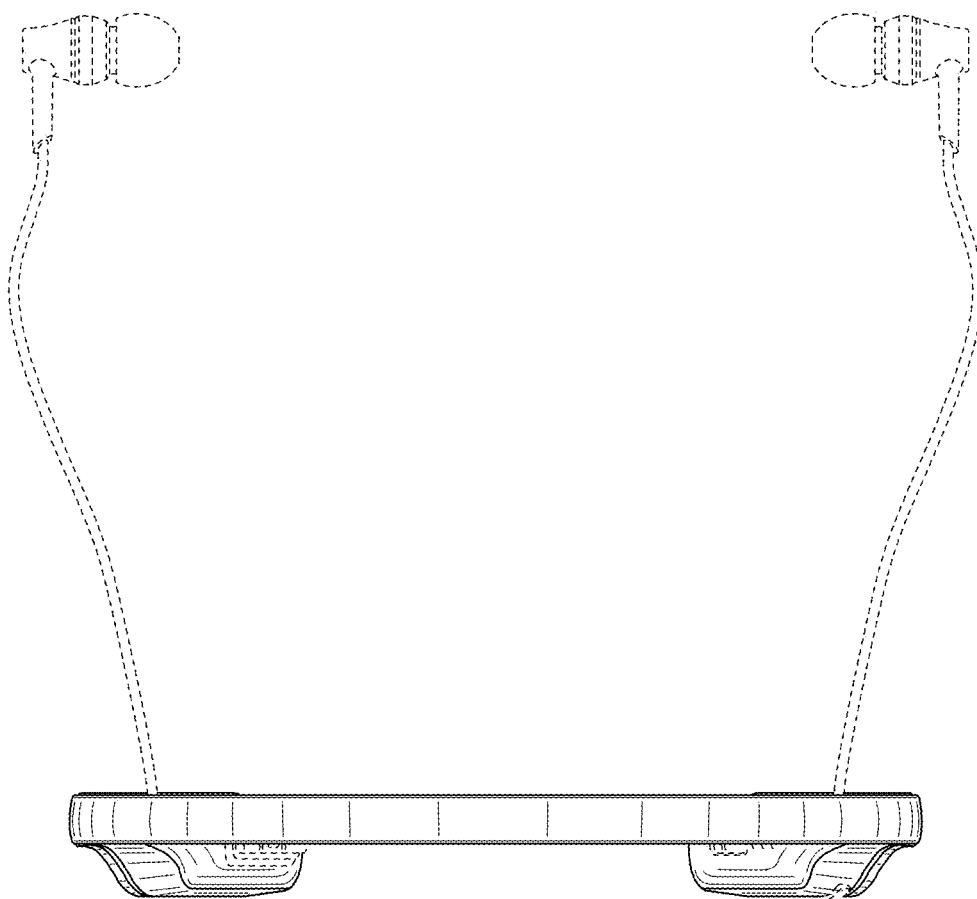


FIG. 5

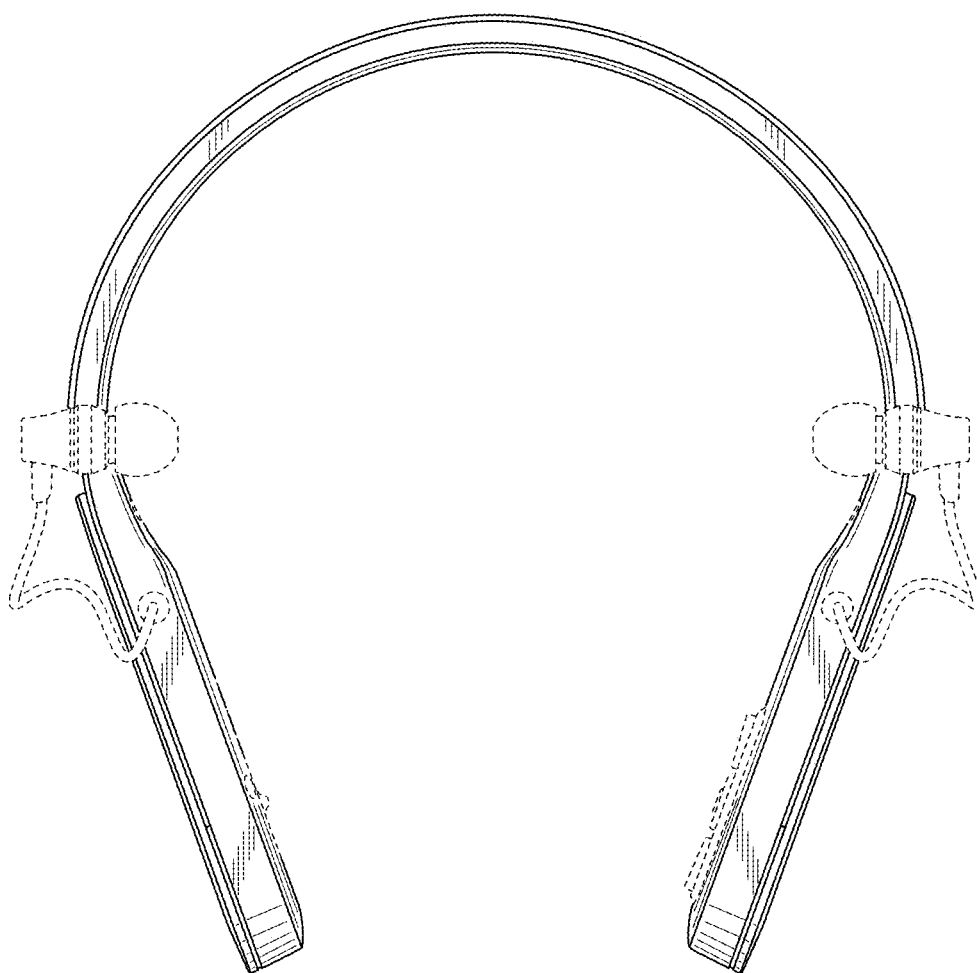


FIG. 6

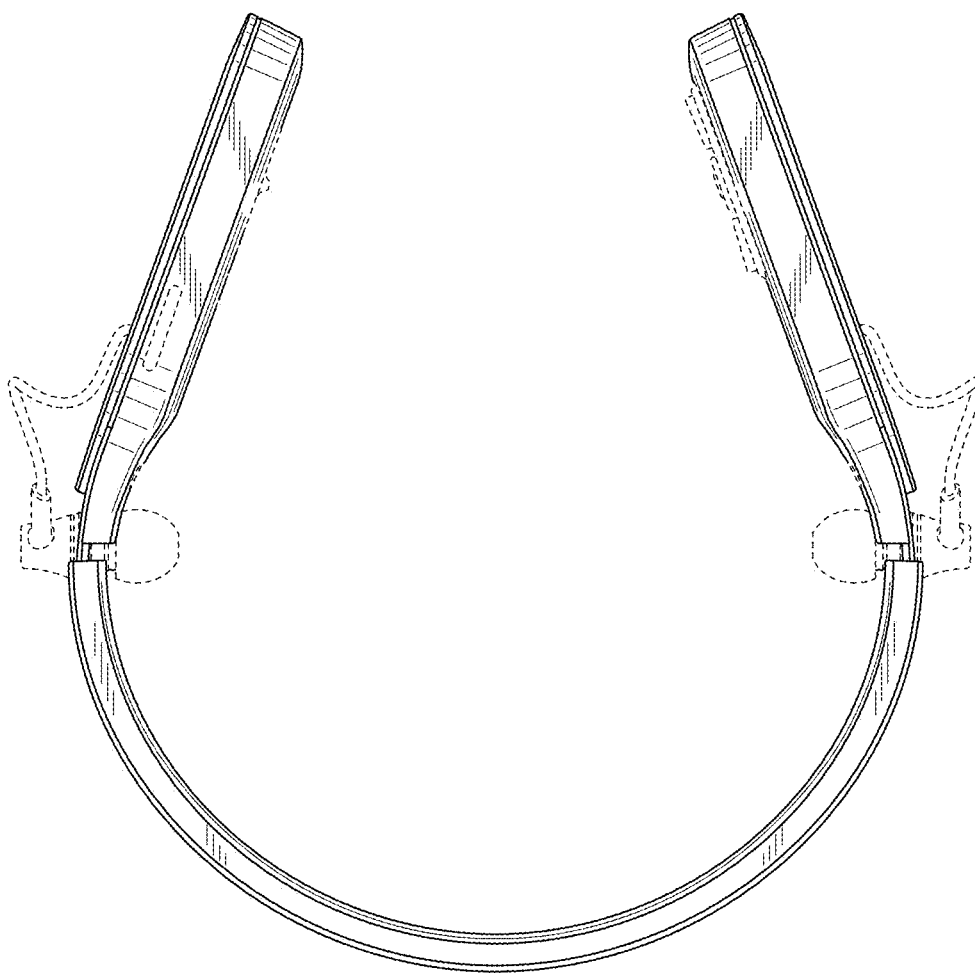


FIG. 7

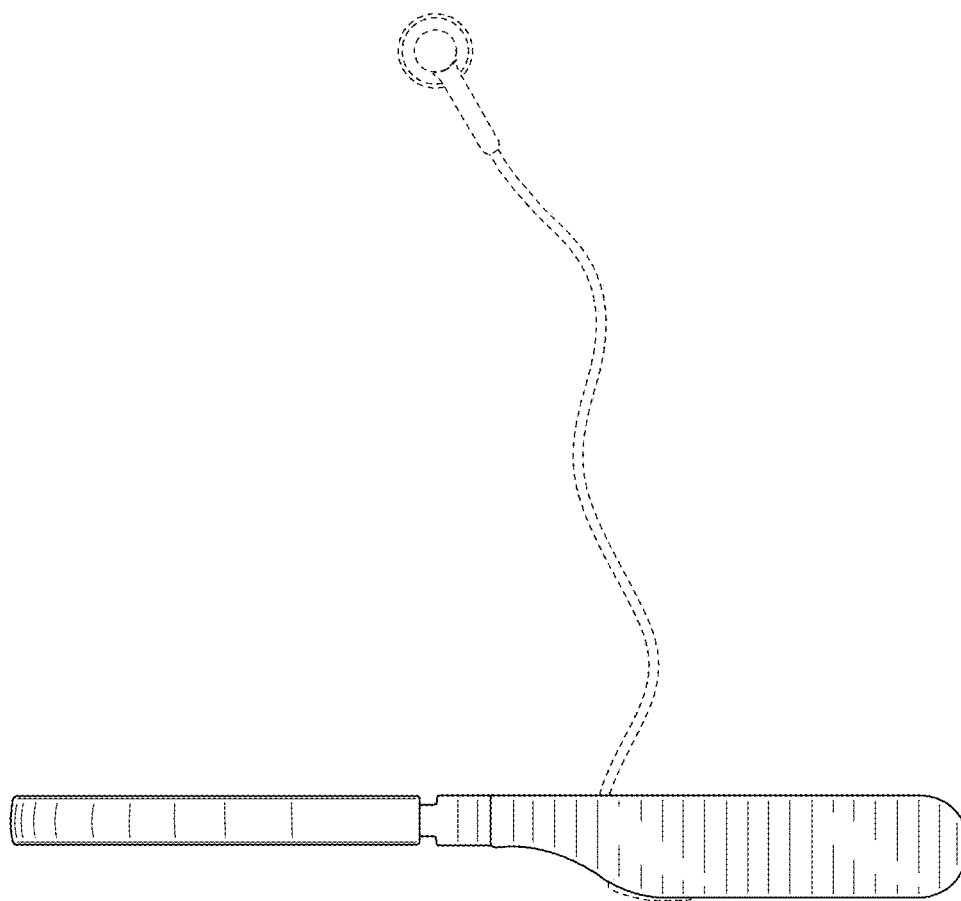


FIG. 8

